TOSHIBA Photocoupler GaAs Ired & Photo-Triac

TLP560G

Triac Driver
Programmable Controllers
AC-Output Module
Solid State Relay

The TOSHIBA TLP560G consists of a photo–triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

- Peak off-state voltage: 400 V (min)
- On-state current: 100 mA (max)
- Isolation voltage: 2500 V_{rms} (min)
- UL recognized: File No. E67349
- Isolation operating voltage: 2500 V_{ac} or 300 V_{dc} for isolation group C^{\star_1}
- Trigger LED current

	Trigger LED	Maulina of	
Classification*	$V_T = 6V$,	Marking of Classification	
	Min.	Max.	Classification
(IFT5)	_	5	T5
(IFT7)	_	7	T5, T7
Standard	_	10	T5, T7, blank

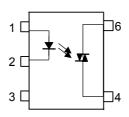
*Ex. (IFT5); TLP560G(IFT5)
(Note) Application type name for certification test, please use standard product type name, i.e.
TLP560G(IFT5): TLP560G

*1: According to VDE0110, table 4.

Unit: mm 3 2 1 1 5 5 6 6 7 7.62 ± 0.25 7.62 ± 0.25 7.62 ± 0.25 7.85 ~ 8.80 11-7A9

Weight: 0.39g (typ.)

Pin Configuration (top view)



- 1 : Anode
- 2: Cathode
- 3 : N.C.
- 4: Terminal 1
- 6: Terminal 2

Start of commercial production 1984

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
	Forward current	l _F	50	mA	
	Forward current derating (Ta ≥	ΔI _F / °C	-0.7	mA / °C	
LED	Peak forward current (100µs pu	I _{FP}	1	Α	
	Reverse voltage	V _R	5	V	
	Junction temperature	Tj	125	°C	
	Off-state output terminal voltage	V_{DRM}	400	V	
	On-state RMS current	Ta = 25°C	l=(p, io)	100	mA
Detector		Ta = 70°C	l _{T(RMS)}	50	IIIA
	On-state current derating (Ta ≥	ΔI _T / °C	-1.1	mA / °C	
	Peak on-state current (100µs p	I _{TP}	2	Α	
	Peak nonrepetitive surge currer (Pw = 10ms)	I _{TSM}	1.2	Α	
	Junction temperature	Tj	115	°C	
Storage temperature range			T _{stg}	-55 to 125	°C
Operating temperature range			T _{opr}	-40 to 100	°C
Lead soldering temperature (10s)			T _{sol}	260	°C
Isolation voltage (AC, 1 minute, R.H. ≤ 60%)			BVS	2500	V _{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	V_{AC}	_	_	120	V _{ac}
Forward current	lF	15	20	25	mA
Peak on-state current	I _{TP}	_	_	1	Α
Operating temperature	T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

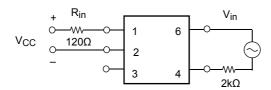
Individual Electrical Characteristics (Ta = 25°C)

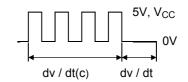
Characteristic		Symbol	Test Condition		Тур.	Max	Unit
LED	Forward voltage	V _F	I _F = 10mA	1.0	1.15	1.3	V
	Reverse current	I _R	V _R = 5V		_	10	μA
	Capacitance	C _T	V = 0, f = 1 MHz		10	_	pF
Detector	Peak off-state current	I _{DRM}	V _{DRM} = 400 V	_	10	100	nA
	Peak on-state voltage	V _{TM}	I _{TM} = 100 mA	_	1.7	3.0	V
	Holding current	lΗ	_	_	0.6	_	mA
	Critical rate of rise of off–state voltage	dv / dt	V _{in} = 120 V _{rms} , Ta = 85 °C (Fig	1) 200	500	_	V / µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V_{in} = 30 V_{rms} , I_T = 15 mA (Fig	1) -	0.2	_	V / µs

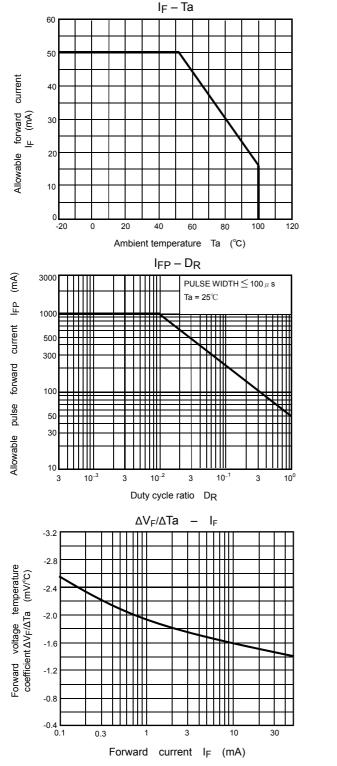
Coupled Electrical Characteristics (Ta = 25°C)

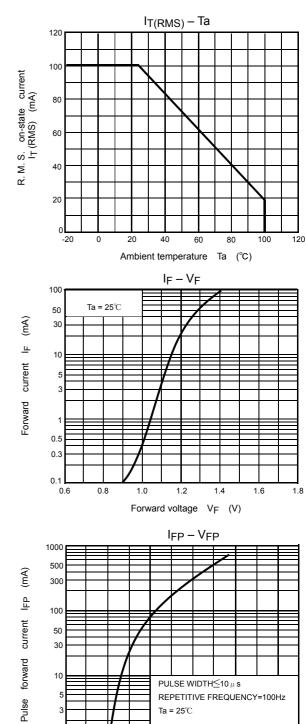
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}	V _T = 3V	_	5	10	mA
Capacitance (input to output)	CS	V _S = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H.≦60%	5×10 ¹⁰	10 ¹⁴	_	Ω
	BVS	AC, 1 minute	2500	_	_	.,
Isolation voltage		AC, 1 second, in oil	_	5000	_	V _{rms}
		DC, 1 minute, in oil	_	5000	_	V _{dc}

Fig.1: dv / dt test circuit









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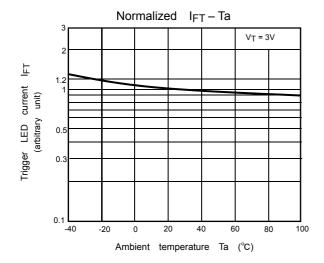
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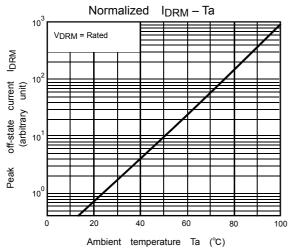
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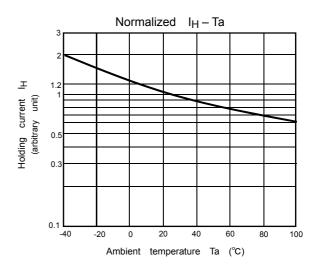
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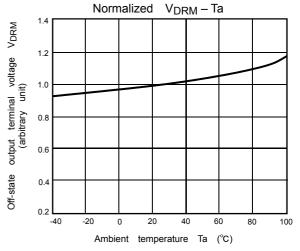
Pulse forward voltage VFP (V)

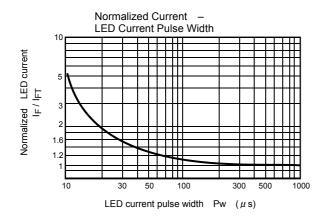
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